



Part Number : 714391864

Product Description : 1.00mm Mezz (IEEE 1386)
Receptacle, Surface Mount, Dual Row, Vertical
Stacking, Embossed Tape on Reel, 0.76µm Gold (Au),
64 Circuits Pick and Place Cap



Series Number : 71439

Status : Active

Product Category : Board-to-Board Connectors

Documents & Resources

Drawings

[714391864_sd.pdf](#)

[PK-70873-063-001.pdf](#)

3D Models and Design Files

[STEP AP242](#)

[SOLIDWORKS](#)

[Creo](#)

Specifications

[PS-71436-9999-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	ⓘ per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)6225-DC (07 Nov 2024)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS

- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	Board-to-Board Connectors
Series	71439
Description	1.00mm Mezz (IEEE 1386) Receptacle, Surface Mount, Dual Row, Vertical Stacking, Embossed Tape on Reel, 0.76µm Gold (Au), 64 Circuits Pick and Place Cap
Application	Board-to-Board, Signal, Mezzanine
Component Type	PCB Receptacle
Product Name	1.00mm Mezzanine (IEEE 1386)
UPC	800754350037

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	100V

Physical

Circuits (Loaded)	64
Circuits (maximum)	64
Color - Resin	Natural
Flammability	94V-0
Glow-Wire Capable	No
Lock to Mating Part	Yes
Mated Height	11.00mm, 12.00mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	1.100/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Embossed Tape on Reel
PCB Locator	Yes
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	1.00mm
Plating min - Mating	0.762µm
Plating min - Termination	1.905µm
Polarized to PCB	No
Robotic Placement	Pick and Place Cap
Temperature Range - Operating	-55° to +85°C
Termination Interface Style	Surface Mount

Solder Process Data

Lead-Free Process Capability	REFLOW
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
1.00mm Mezz (IEEE 1386) Vertical	71436

